



# EDCON-COMPONENTS



Designed for surface mounting on high density circuit board

Emboss carrier tape packing systems is available for automatic insertion



## Technical Informations

Voltage:	<b>35Volt</b>
Range:	<b>1000µF</b>
Dimension; D x L mm	<b>12,5x16mm</b>
Impedance (Ω) max., at20°C, 100hKz	<b>no specified</b>
Ripple Current (mA rms) at 105°C, 100kHz	<b>600mA</b>

Ordering Code			
<b>350</b>	<b>Voltage</b>		
<b>102</b>	<b>Range</b>		
<b>D=</b>	<b>I</b>	<b>L=</b>	<b>6</b>

Operating Temperatur Range of -40°C ~ +85°C

Load Life of 1000~2000 hours at 85°C

<b>Leakage current max.</b>	Ø4 ~ Ø10mm	I= 0,01CV or 3µA whichever is greater ( after 2 minutes)									
	Ø12,5 ~ Ø16mm	I= 0,03CV or 4µA whichever is greater ( after 1 minutes)									
<b>Capacitance tolerance</b>	± 20% at 120Hz, 20°C										
<b>Dissipation factor max. (at 120Hz, 20°C)</b>	WV		4,0	6,3	10	16	25	35	50	63	100
	Tanδ	Ø4 ~ Ø10mm	0,42	0,30	0,26	0,22	0,16	0,14	0,21	0,12	0,12
		Ø12,5 ~ Ø16mm	0,45	0,38	0,34	0,30	0,26	0,22	0,18	0,14	0,12

<b>Low Temperatur characteristics ( Impedance ratio at 120Hz )</b>	WV		4,0	6,3	10	16	25	35	50	63	100
	Ø4 ~ Ø10mm	Z-25°C / Z+20°C	7	4	3	2	2	2	2	2	2
		Z-40°C / Z+20°C	15	8	6	4	4	3	3	3	4
	Ø12,5 ~ Ø16mm	Z-25°C / Z+20°C	7	5	4	3	2	2	2	2	2
Z-40°C / Z+20°C		17	12	10	8	5	4	3	3	3	

<b>Load Life ( after application of the rated voltage for 1000hrs at 105°C</b>	Leakage current	Less than specified value									
	Capacitance Change	Within ±20% of initial value									
		Within ±30% of initial value for 4V & 6,3V									
	Tanδ	Less than 200% of specified value									
<b>Shell life (at 85°C)</b>	Ø4 ~ , Ø6,3x5,4: 1000hours										
	After 1000hours no load test, leakage current, capacitance and tanδ are same as load life value.										

**CHIP Wide Temperature Range 105°C**

Part No.: **I15005**

DRW:	Jason	CHKD	Wilson	MATL:	Wilson	TOLERANCE	Mason	DATE	03.06.2014
APPD:	Schumi			FINISH	Jamy		Sheet No.		2 from 7

Customer:

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<b>Resistance to soldering heat</b>	After reflow soldering and resistance at room temperature, they meet the characteristics requirements listed at underside	
	Leakage current	Less than specified value
	Capacitance Change	Within $\pm 10\%$ of initial value
	Tan $\delta$	Less than specified value

FREQUENCY COEFFICIENT OF PERMISSIBLE RIPPLE CURRENT						
Diameter	Capacitance	Frequency				
	$\mu\text{F}$	50Hz	120Hz	300Hz	1KHz	10KHz $\leq$
$\varnothing 4 \sim \varnothing 10\text{mm}$	0,1 ~68	0,70	1,00	1,17	1,36	1,50
	100 ~3300	0,85	1,00	1,08	1,20	1,30
$\varnothing 12,5 \sim \varnothing 16\text{mm}$	~68	0,75	1,00	1,35	1,57	2,00
	100 ~680	0,80	1,00	1,23	1,34	1,50
	1000 ~6800	0,85	1,00	1,10	1,13	1,15

<b>CHIP Wide Temperature Range 105°C</b>	
Part No.:	<b>I15005</b>
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## Technical Drawing

### Dimension of Size Ø 8x10,5 ~ 16mm



### Dimension of Size Ø 4~ 8x6,2mm



D x L	Ø 4 x 5,4	Ø 5 x 5,4	Ø 6,3 x 5,4	Ø 6,3 x 7,7	Ø 8 x 6,2	Ø 8 x 10,5	Ø 10 x 10,5	Ø 10 x 13,5	Ø 12,5 x 13,5	Ø 12,5 x 16	Ø 16 x 16,5
A	1,8	2,1	2,4	2,4	3,3	2,9	3,2	3,2	4,7	4,7	5,5
B	4,3	5,3	6,6	6,6	8,3	8,3	10,3	10,3	12,8	12,8	16,3
C	4,3	5,3	6,6	6,6	8,3	8,3	10,3	10,3	12,8	12,8	16,3
E +/-0.2	1,0	1,3	2,2	2,2	2,2	3,1	4,4	4,4	4,4	4,4	6,7
L	5,4	5,4	5,4	7,7	6,2	10,5	10,5	13,5	13,5	16,0	16,5

\*1 Voltage mark (6V) represents 6,3V for Ø 4 ~ 10mm

\*3 (L +/- 0.5) is applicable to Ø 8x10,5 ~ Ø 10mm

\*2 (L +/- 0.3) is applicable to Ø 6,3 ~ 7.7 and Ø 8 + 6,2mm

\*4 (L +/- 1.0) is applicable to Ø 12,5 ~ Ø 16mm

RE. Date code and seriew type -1st digit for Year 2nd digit for Quarter, 4 quarter codes in one year area 1,4,7,0  
 3rd character for Serie S

**CHIP Wide Temperature  
 Range 105°C**

Part No.: **I15005**

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## Ordering Informations

Serie	Voltage Code	Tolerance Code	Range Code	Size Code D	Size Code L	Special function	ROHS	Packing Code		
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<b>I15005</b>	<b>350</b>	<b>M</b>	<b>102</b>	<b>I</b>	<b>6</b>	<b>XX</b>	<b>R</b>	<b>TR</b>		
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look table Voltage Code	<b>M= ±20%</b>	Ordering Code Range	Look table Code D	Look table Code L	<b>XX= No function</b>	<b>R= ROHS Conform</b> <b>N= NON ROHS Conform</b>	<b>TR= Tape Reel Packing</b>		
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**BU= Bulk-Ware**

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## Soldering Profile Curve

### Classification Reflow Profile (JEDEC J-STD-020C)



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